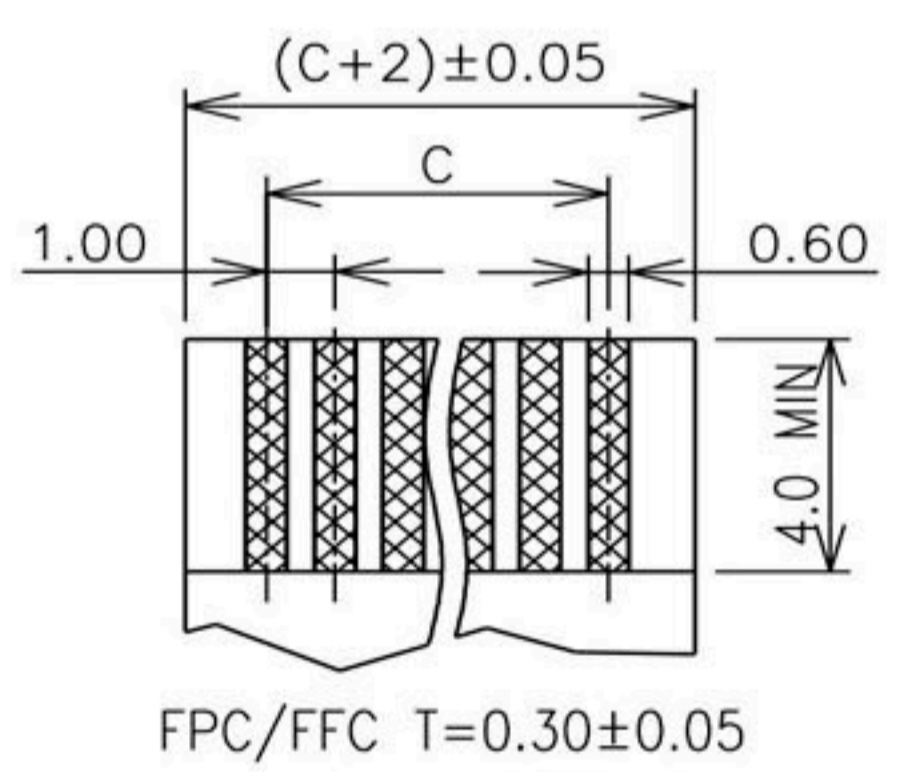
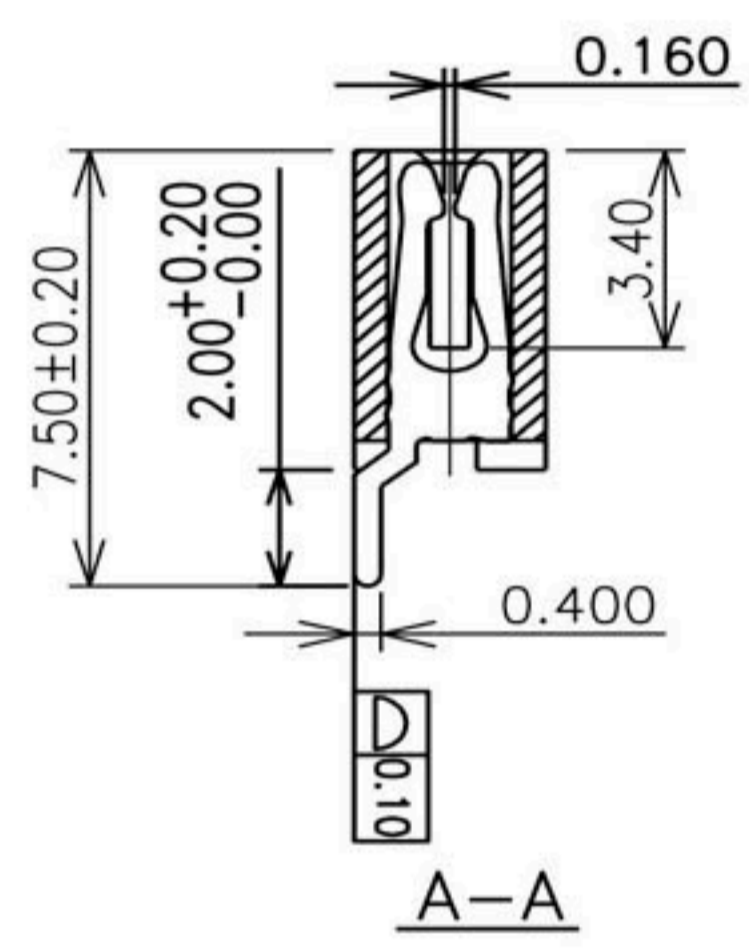


RECOMMENDED PCB LAYOUT



NOTE:

- MATERIAL
HOUSING: GLASS-REINFORCED THERMOPLASTIC UL 94V-0.
CONTACT: COPPER ALLOY.
PLATING: TIN PLATED OVER NICKEL.
- ELECTRICAL
CURRENT RATING: 1.0 AMP.
DIELECTRIC WITHSTANDING VOLTAGE: 500V AC MIN.
INSULATION RESISTANCE: 500MΩ MIN.
CONTACT RESISTANCE: 30mΩ MAX.
- ENVIRONMENTAL
TEMPERATURE RANGE: -25°C TO +85°C.

■ DIMENSION TABLE

Circuits	Dimension			Circuits	Dimension		
	A	B	C		A	B	C
2	5.00	3.10	1.00	20	23.00	21.10	19.00
3	6.00	4.10	2.00	21	24.00	22.10	20.00
4	7.00	5.10	3.00	22	25.00	23.10	21.00
5	8.00	6.10	4.00	23	26.00	24.10	22.00
6	9.00	7.10	5.00	24	27.00	25.10	23.00
7	10.00	8.10	6.00	25	28.00	26.10	24.00
8	11.00	9.10	7.00	26	29.00	27.10	25.00
9	12.00	10.10	8.00	27	30.00	28.10	26.00
10	13.00	11.10	9.00	28	31.00	29.10	27.00
11	14.00	12.10	10.00	29	32.00	30.10	28.00
12	15.00	13.10	11.00	30	33.00	31.10	29.00
13	16.00	14.10	12.00	31	34.00	32.10	30.00
14	17.00	15.10	13.00	32	35.00	33.10	31.00
15	18.00	16.10	14.00	33	36.00	34.10	32.00
16	19.00	17.10	15.00	34	37.00	35.10	33.00
17	20.00	18.10	16.00	35	38.00	36.10	34.00
18	21.00	19.10	17.00	36	39.00	37.10	35.00
19	22.00	20.10	18.00				

<p>RoHS Compliant</p>		<p>HSM 玄茂科技股份有限公司 HSUAN MAO TECHNOLOGY CO., LTD.</p>	
<p>APPD. 核准</p>		<p>TOLERANCE 容許公差</p> <p>.0 ± 0.2</p> <p>.00 ± 0.1</p> <p>ANG. ±</p>	<p>PART NAME 品名</p> <p>NON ZIF/FPC 1.0mm SMT SIDE ENTRY XXP TIN PLATING BLACK COLOR ROHS</p>
<p>DWG. 製圖</p> <p>Helen</p>	<p>SCALE 比例</p> <p>參考</p>	<p>UNIT 單位</p> <p>MM</p>	<p>PART NO. 料號</p> <p>C3921-XXITXB00R</p>
<p>DATE 制表日</p> <p>2012/8/28</p>	<p>PAGE 張數</p> <p>1 OF 1</p>	<p>REV. 版本</p> <p>A</p>	